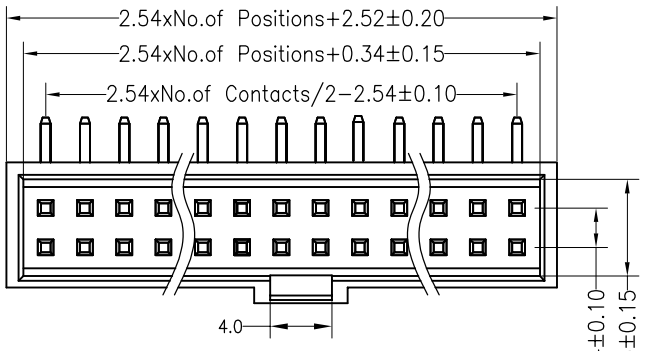
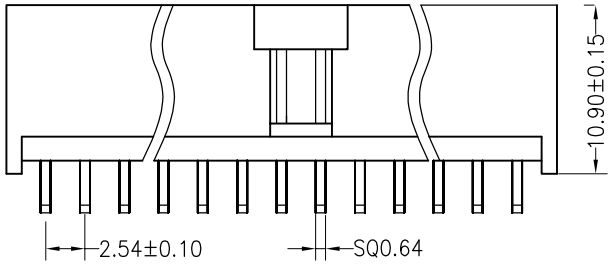
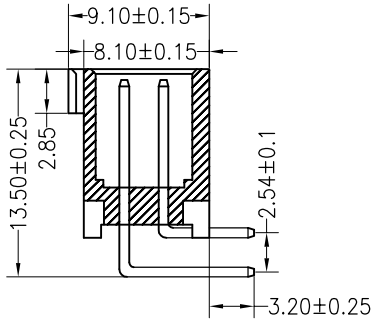
HSF RoHS

SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PBT
Max.Processing Temp: 180°C for 30−60 seconds
(200°C for 10 seconds)



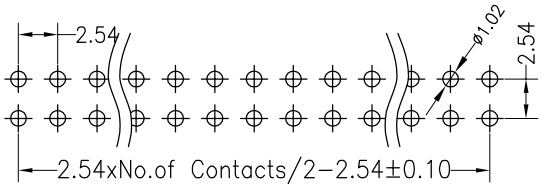




Ordering Information

3211 - XX R XX X B K00 X 01

- XX — No.of Pins Per Row 6--64
- XX — Contact Plating
  G0:Gold Flash
  G1:1U" Gold
  G2:1.5U" Gold
  G3:2U" Gold
  G4:3U" Gold
  G5:5U" Gold
  S0:Gold Flash/Tin
  SN:Tin
- X — Insulator Material Option
  A=BK−PBT
  C=BK−PA6T
  D=BK−PA46
  E=BK−PA9T
  F=BK−LCP
- X — Packing
  0=PE Bag
  A=Tray
  T=Tube
  P=Tube+Cap
  R=Reel+Cap
  M=Reel+Mylar



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2016.08.26	NEW DRAWING	

OPERATION	
X.X	±0.30
X.XX	±0.20
X.XXX	±0.10
Angle	±3°
DIM	TOL

DRAW	Liu Miao	16.08.26
CHECK		
APPROVE		

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司 SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	3211−XXRXXXBK00X01
TITLE:	2.54mm Box Header 90°